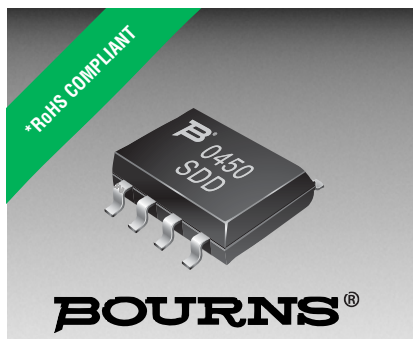




Features

- RoHS compliant*
- Protects up to four I/O ports
- Surge protection
- ESD protection
- Low capacitance: 6 pF

Applications

- Ethernet - 10/100 Base T
- Personal digital assistants
- LAN devices
- Instrumentation

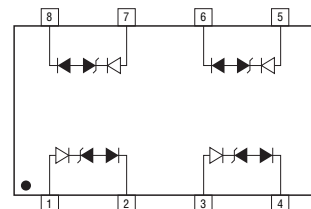
CDNBS08-SLVU2.8-4 - Low Capacitance TVS Array

General Information

The markets of portable communications, computing and video equipment are challenging the semiconductor industry to develop increasingly smaller electronic components.

Bourns offers Transient Voltage Suppressor Array combination diodes for surge and ESD protection applications in an eight lead narrow body SOIC package size format. Bourns® Chip Diodes conform to JEDEC standards, are easy to handle on standard pick and place equipment and their flat configuration minimizes roll away.

The Bourns® device will meet IEC 61000-4-2 (ESD), IEC 61000-4-4 (EFT) and IEC 61000-4-5 (Surge) requirements.



Electrical Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Min.	Nom.	Max.	Unit
Peak Pulse Current ($t_p = 8/20 \mu\text{s}$)	I_{PP}			30	A
Peak Pulse Power ($t_p = 8/20 \mu\text{s}$) ¹	P_{PP}			600	W
Working Voltage	V_{WM}			2.8	V
Breakdown Voltage @ 1 mA	V_{BR}	3.0			V
Leakage Current @ V_{WM}	I_D		0.1	1.0	μA
Capacitance @ 0 V, 1 MHz	C		6		pF
Snapback Voltage @ 50 mA		2.8			V
ESD Protection per IEC 61000-4-2 Contact Discharge Air Discharge	ESD	± 8 ± 15		± 30 ± 30	kV
EFT Protection per IEC 61000-4-4 @ 5/50 ns	EFT			60	A
Surge Protection per IEC 61000-4-5 Clamping Voltage @ 8/20 μs	@ $I_P = 5 \text{ A}$ ²	V_C		10	V
	@ $I_P = 24 \text{ A}$ ²	V_C	13	15	V
	@ $I_{PP} = 30 \text{ A}$ ²	V_C	15	21	V

Notes:

1. See Peak Pulse Power vs. Pulse Time.
2. Each differential line pair.

Thermal Characteristics (@ $T_A = 25^\circ\text{C}$ Unless Otherwise Noted)

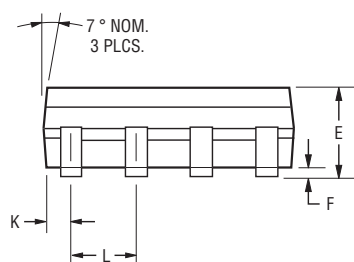
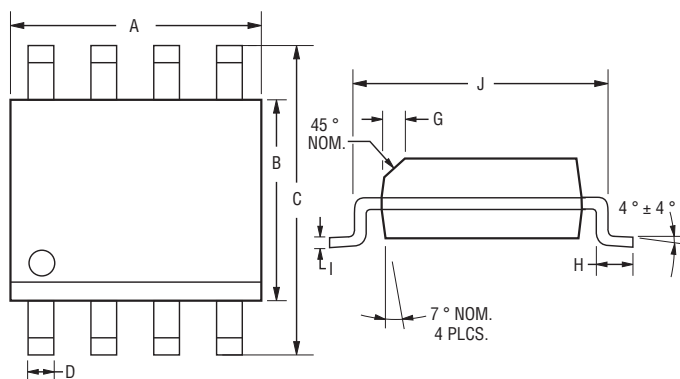
Parameter	Symbol	Min.	Nom.	Max.	Unit
Junction Temperature Range	T_J	-55	+25	+125	$^\circ\text{C}$
Storage Temperature Range	T_{STG}	-55	+25	+150	$^\circ\text{C}$

CDNBS08-SLVU2.8-4 - Low Capacitance TVS Array

BOURNS®

Product Dimensions

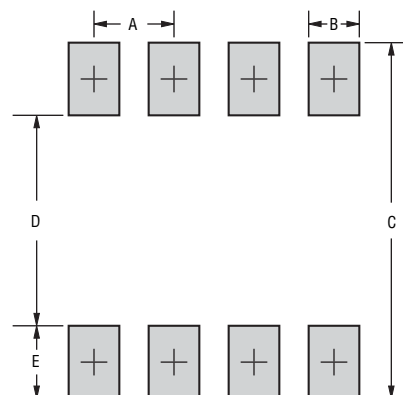
This is an RoHS compliant molded JEDEC narrow body SO-8 package with 100 % Sn plating on the lead frame. It weighs approximately 15 mg and has a flammability rating of UL 94V-0.



DIMENSIONS = $\frac{\text{MILLIMETERS}}{\text{(INCHES)}}$

Dimensions	
A	$\frac{4.80 - 5.00}{(0.189 - 0.197)}$
B	$\frac{3.81 - 4.00}{(0.150 - 0.157)}$
C	$\frac{5.80 - 6.20}{(0.228 \pm 0.244)}$
D	$\frac{0.36 - 0.51}{(0.014 - 0.020)}$
E	$\frac{1.35 - 1.75}{(0.053 - 0.069)}$
F	$\frac{0.102 - 0.203}{(0.004 - 0.008)}$
G	$\frac{0.25 - 0.50}{(0.010 - 0.020)}$
H	$\frac{0.51 - 1.12}{(0.020 - 0.044)}$
I	$\frac{0.190 - 0.229}{(0.0075 - 0.0090)}$
J	$\frac{4.60 - 5.21}{(0.181 - 0.205)}$
K	$\frac{0.28 - 0.79}{(0.011 - 0.031)}$
L	$\frac{1.27}{(0.050)}$

Recommended Footprint



Dimensions	
A	$\frac{1.143 - 1.397}{(0.045 - 0.065)}$
B	$\frac{0.635 - 0.889}{(0.025 - 0.035)}$
C	$\frac{6.223}{(0.245)} \text{ Min.}$
D	$\frac{3.937 - 4.191}{(0.155 - 0.165)}$
E	$\frac{1.016 - 1.27}{(0.040 - 0.050)}$

Typical Part Marking

CDNBS08-SLVU2.8-4 **B** SL4

How to Order

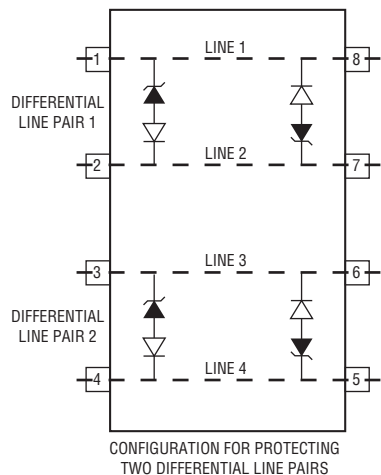
CD NBS08 - SLVU 2.8 - 4

Common Code _____
 Chip Diode _____
 Package _____
 NBS08 = Narrow Body SOIC8 Package
 Model _____
 SLVU = Low Capacitance TVS Array
 Working Peak Reverse Voltage _____
 2.8 = 2.8 V_{RWM} (Volts)
 Number of Diodes _____

Specifications are subject to change without notice.
 Customers should verify actual device performance in their specific applications.

CDNBS08-SLVU2.8-4 - Low Capacitance TVS Array

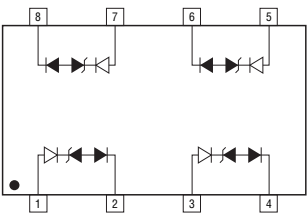
Application Diagram



Device Pinout

Pin	Unidirectional Common Mode	Bidirectional Common Mode	Bidirectional Differential Mode
1	Line 1	Line 1	Line Pair 1
2	GND	GND	Line Pair 1
3	Line 3	GND	Line Pair 2
4	GND	Line 2	Line Pair 2
5	Line 4	Line 2	Line Pair 2
6	GND	GND	Line Pair 2
7	Line 2	GND	Line Pair 1
8	GND	Line 1	Line Pair 1

Block Diagram

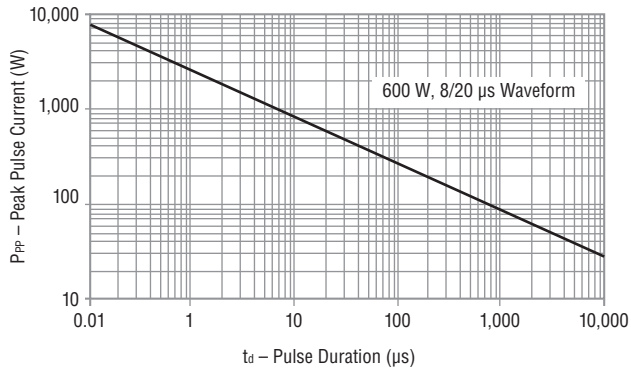


CDNBS08-SLVU2.8-4 - Low Capacitance TVS Array

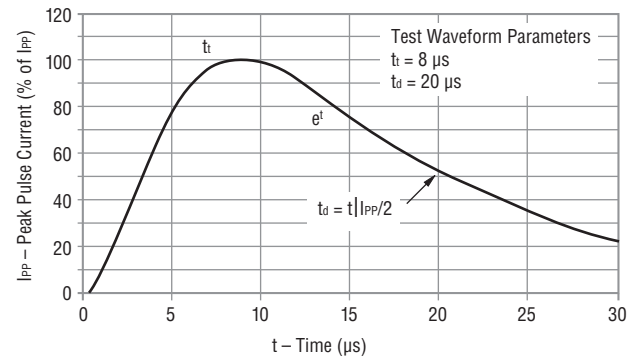
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Performance Graphs

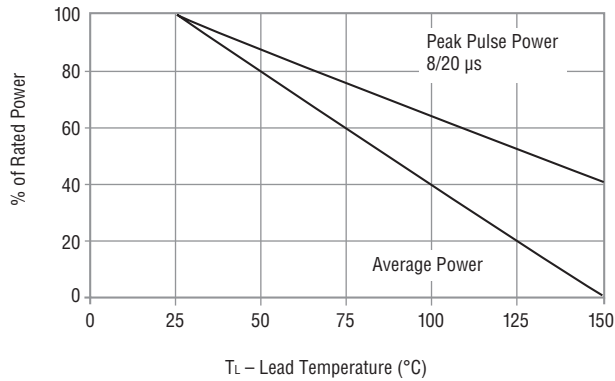
Peak Pulse Power vs Pulse Time



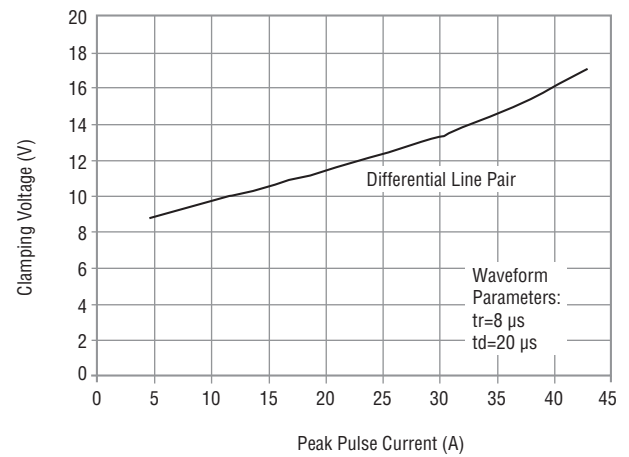
Pulse Waveform



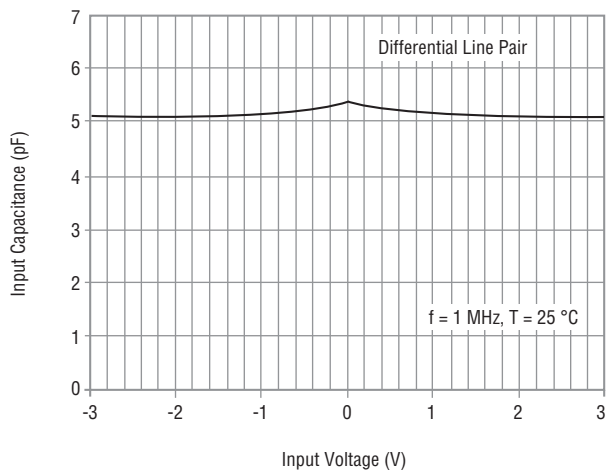
Power Derating Curve



Clamping Voltage vs. Peak Pulse Current



Variation of C_{in} vs. V_{in}



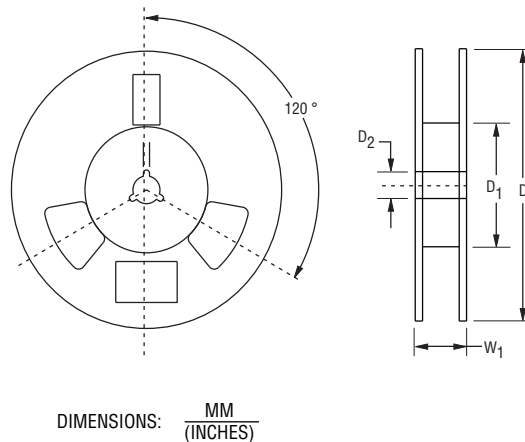
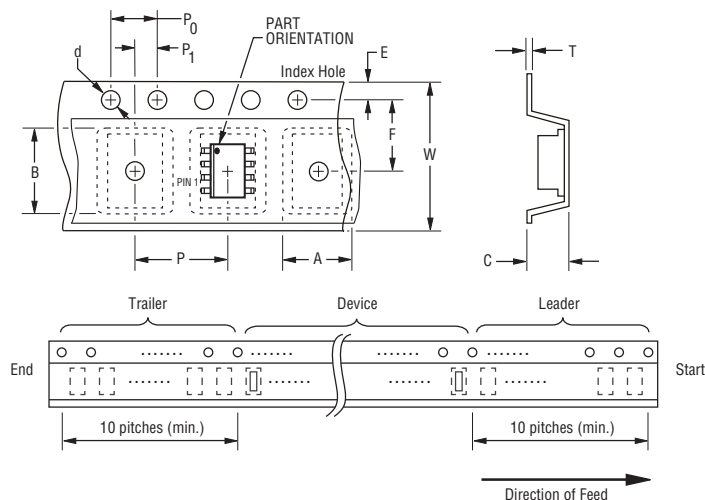
Specifications are subject to change without notice. Customers should verify actual device performance in their specific applications.

CDNBS08-SLVU2.8-4 - Low Capacitance TVS Array

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Packaging Information

The product is packaged in tape and reel format per EIA-481 standard.



Item	Symbol	NSOIC 8L
Carrier Width	A	$\frac{6.7 \pm 0.10}{(0.264 \pm 0.004)}$
Carrier Length	B	$\frac{5.5 \pm 0.10}{(0.217 \pm 0.004)}$
Carrier Depth	C	$\frac{2.10 \pm 0.10}{(0.083 \pm 0.004)}$
Sprocket Hole	d	$\frac{1.55 \pm 0.05}{(0.061 \pm 0.002)}$
Reel Outside Diameter	D	$\frac{330}{(12.992)}$
Reel Inner Diameter	D ₁	$\frac{80.0}{(3.1500)}$ MIN.
Feed Hole Diameter	D ₂	$\frac{13.0 \pm 0.20}{(0.512 \pm 0.008)}$
Sprocket Hole Position	E	$\frac{1.75 \pm 0.10}{(0.069 \pm 0.004)}$
Punch Hole Position	F	$\frac{3.50 \pm 0.05}{(0.138 \pm 0.002)}$
Punch Hole Pitch	P	$\frac{8.00 \pm 0.10}{(0.315 \pm 0.004)}$
Sprocket Hole Pitch	P ₀	$\frac{4.00 \pm 0.10}{(0.157 \pm 0.004)}$
Embossment Center	P ₁	$\frac{2.00 \pm 0.05}{(0.079 \pm 0.002)}$
Overall Tape Thickness	T	$\frac{0.20 \pm 0.10}{(0.008 \pm 0.004)}$
Tape Width	W	$\frac{12.00 \pm 0.20}{(0.472 \pm 0.008)}$
Reel Width	W ₁	$\frac{18.4}{(0.724)}$ MAX.
Quantity per Reel	--	2500

REV. 12/12

Specifications are subject to change without notice.

Customers should verify actual device performance in their specific applications.

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Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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